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February 2006

FAIRCHILD

SEMICONDUCTOR®

FDS8884 N-Channel PowerTrench[®] MOSFET

30V, 8.5A, 23mΩ

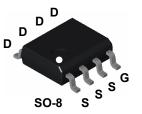
General Descriptions

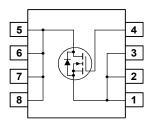
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $r_{DS(on)}$ and fast switching speed.

Features

- Max $r_{DS(on)} = 23m\Omega$ at $V_{GS} = 10V$, $I_D = 8.5A$
- Max $r_{DS(on)} = 30m\Omega$ at $V_{GS} = 4.5V$, $I_D = 7.5A$
- Low gate charge
- 100% R_G Tested
- RoHS Compliant







MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

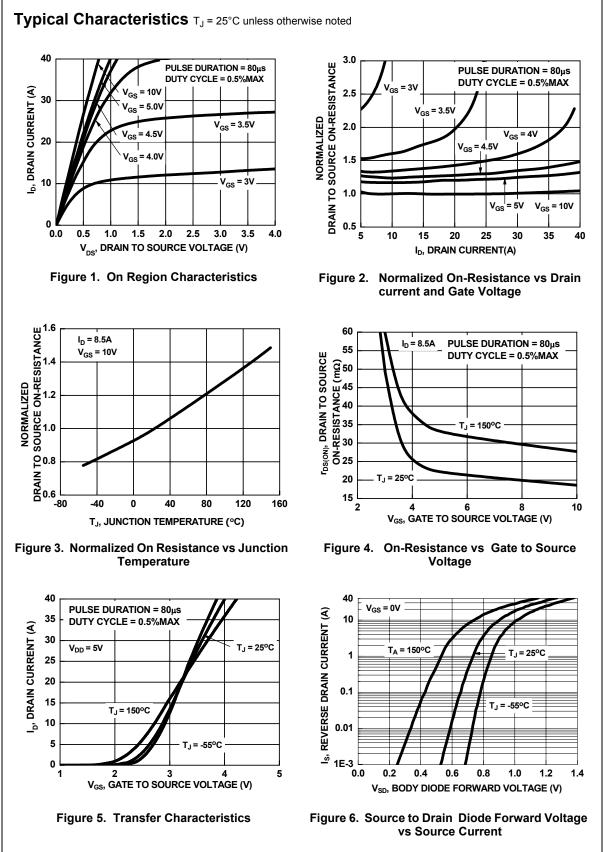
Symbol	Parameter		Ratings	Units V
V _{DS}	Drain to Source Voltage		30	
V _{GS}	Gate to Source Voltage		±20	V
	Drain Current Continuous	(Note 1a)	8.5	А
D	Pulsed		40	A
E _{AS}	Single Pulse Avalanche Energy	(Note 2)	32	mJ
6	Power dissipation		2.5	W
P _D	Derate above 25°C		20	mW/ºC
T _J , T _{STG}	Operating and Storage Temperature		-55 to 150	°C
Therma	I Characteristics			
R _{0JA}	Thermal Resistance, Junction to Ambient	(Note 1a)	50	°C/W
$R_{ heta J A}$	Thermal Resistance, Junction to Case	(Note 1)	25	°C/W

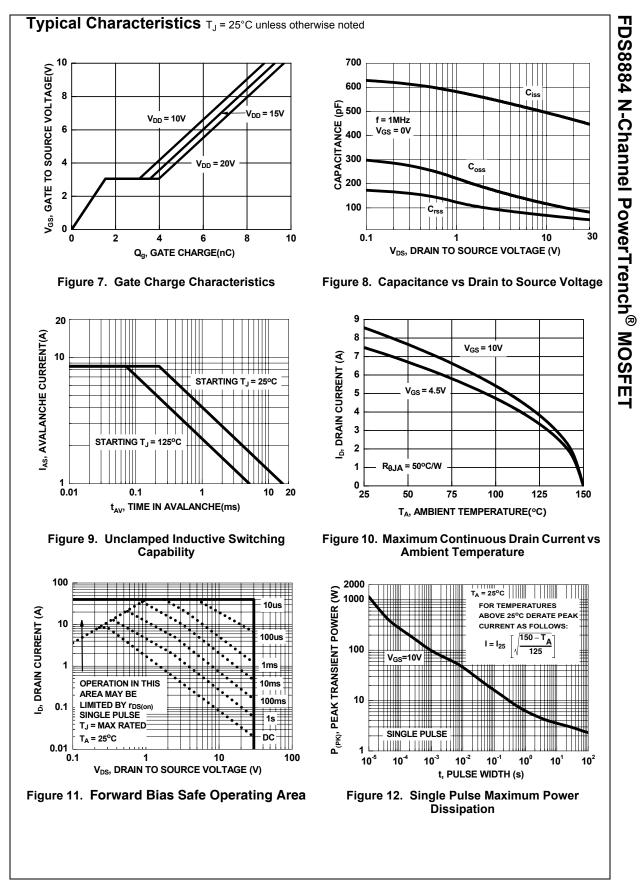
Package Marking and Ordering Information

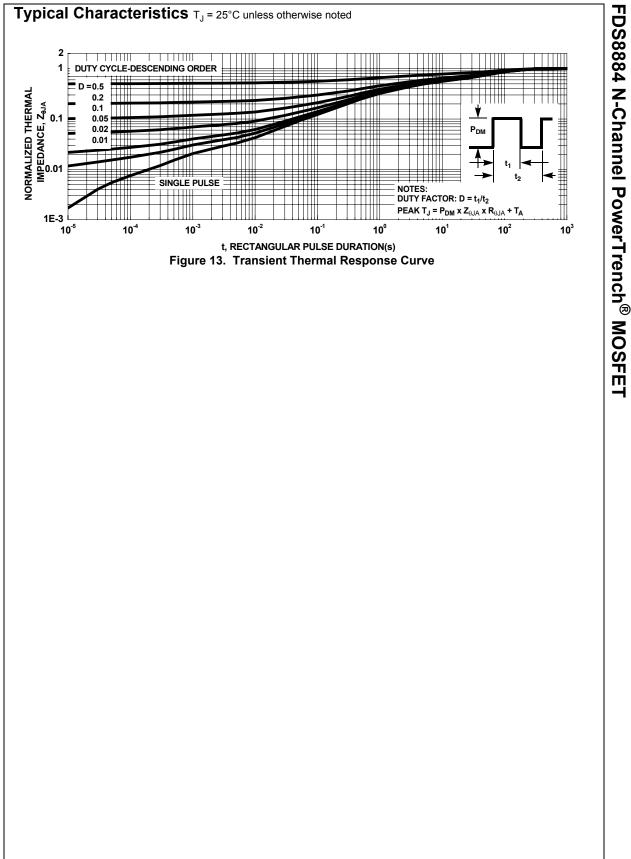
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDS8884	FDS8884	SO-8	330mm	12mm	2500 units

Parameter	Test Conditions	Min	Тур	Max	Units
teristics					
Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	30			V
Breakdown Voltage Temperature	$I_D = 250 \mu A$, referenced to				-
Coefficient	25°C	23	23		mV/ºC
	$V_{DS} = 24V$			1	
Zero Gate Voltage Drain Current					μA
Gate to Source Leakage Current				±100	nA
teristics (Note 3)				1	1
, <i>,</i>	$V_{00} = V_{00}$ la = 250µA	12	17	25	V
		1.2	1.7	2.5	-
5	$1D = 250\mu$ A, referenced to 25° C		-4.9		mV/ºC
	$V_{CC} = 10V$, $I_{C} = 8.5A$.		19	23	
			-	-	
Drain to Source On Resistance					mΩ
	$T_{\rm J} = 125^{\circ}C$		26	32	
Characteristics					
			475	635	pF
					pF
	f = 1MHz			-	pF
	f – 1MHz			-	Ω
			010		
	1		-	10	
	$V_{DD} = 15V l_{D} = 8.5A$				ns
			-		ns
			42	68	ns
Fall Time			21	34	ns
Total Gate Charge	V _{DS} = 15V, V _{GS} = 10V I _D = 8.5A		9.2	13	nC
Total Gate Charge	$V_{DC} = 15V$, $V_{CC} = 5V$		5.0	7	nC
Gate to Source Gate Charge	$I_{\rm D} = 8.5{\rm A}$		1.5		nC
-			2.0		nC
-					
	I _{SD} = 8.5A		0.9	1.25	V
Source to Drain Diode Voltage			0.8	1.0	V
Reverse Recovery Time					ns
					nC
	Zero Gate Voltage Drain Current Gate to Source Leakage Current eteristics (Note 3) Gate to Source Threshold Voltage Gate to Source Threshold Voltage Temperature Coefficient Drain to Source On Resistance Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics (Note 3) Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	Zero Gate Voltage Drain Current $V_{DS} = 24V$ $V_{GS} = 0V$ $T_J = 125^{\circ}C$ Gate to Source Leakage Current $V_{GS} = \pm 20V$ tteristics (Note 3)Gate to Source Threshold Voltage $V_{GS} = V_{DS}$, $I_D = 250\mu A$ Gate to Source Threshold Voltage $I_D = 250\mu A$, referenced to $25^{\circ}C$ Drain to Source On Resistance $V_{GS} = 10V$, $I_D = 8.5A$, $V_{GS} = 10V$, $I_D = 8.5A$, $T_J = 125^{\circ}C$ Input Capacitance $V_{DS} = 15V$, $V_{GS} = 0V$, $f = 1MHz$ Characteristics $f = 1MHz$ Input Capacitance $f = 1MHz$ Gate Resistance $f = 1MHz$ Characteristics (Note 3) $V_{DD} = 15V$, $I_D = 8.5A$, $V_{GS} = 10V$, $I_D = 8.5A$ Turn-On Delay Time $V_{DS} = 15V$, $V_{GS} = 33\Omega$ Fail Time $V_{DS} = 15V$, $V_{GS} = 10V$ Total Gate Charge $V_{DS} = 15V$, $V_{GS} = 5V$ Gate to Source Gate Charge $I_D = 8.5A$ Gate to Drain Charge $V_{DS} = 15V$, $V_{GS} = 5V$ Gate to Drain Charge $I_{SD} = 8.5A$ Source to Drain Diode Voltage $I_{SD} = 8.5A$ Reverse Recovery Time $I_F = 8.5A$, di/dt = 100A/ μ s	Zero Gate Voltage Drain Current $V_{DS} = 24V$ $V_{GS} = 0V$ $T_J = 125^{\circ}C$ Gate to Source Leakage Current $V_{GS} = \pm 20V$	Zero Gate Voltage Drain Current $V_{DS} = 24V$ $V_{GS} = 0V$ $T_J = 125^{\circ}C$ Gate to Source Leakage Current $V_{GS} = \pm 20V$ $V_{GS} = \pm 20V$ tteristics (Note 3)Gate to Source Threshold Voltage $I_D = 250\muA$, referenced to $25^{\circ}C$ 1.2 1.7 Gate to Source Threshold Voltage $I_D = 250\muA$, referenced to $25^{\circ}C$ -4.9 Drain to Source On Resistance $V_{GS} = 10V, I_D = 8.5A,$ $V_{GS} = 10V, I_D = 8.5A,$ $T_J = 125^{\circ}C$ 26CharacteristicsInput Capacitance Output Capacitance $V_{DS} = 15V, V_{GS} = 0V,$ $f = 1MHz$ 475Output Capacitance Gate Resistance $f = 1MHz$ 0.9Characteristics (Note 3)Turn-On Delay Time Fall Time $V_{DS} = 15V, V_{GS} = 33\Omega$ 42 Fall Time $V_{DS} = 15V, V_{GS} = 10V$ $I_D = 8.5A$ 9 Total Gate Charge Gate to Source Gate Charge Gate to Drain Charge $V_{DS} = 15V, V_{GS} = 5V$ $I_D = 8.5A$ 9.2 Total Gate Charge Gate to Drain Diode Voltage $I_{SD} = 8.5A$ $I_D = 8.5A$ 0.9 Reverse Recovery Time $I_F = 8.5A, di/dt = 100A/\mu s$ 0.9	$\begin{array}{ c c c c c c } \hline V_{DS} = 24V & & & & 1 \\ \hline V_{GS} = 0V & \hline T_J = 125^{\circ}C & & & 250 \\ \hline \end{tabular}$

FDS8884 N-Channel PowerTrench[®] MOSFET







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